

MBCR20JH THRU MBCR20MH
● FEATURES

- * Halogen-free type
- * Internal structure with GPRC (glass passivated rectifier chip) inside
- * Lead free product, compliance to RoHS
- * Lead less chip form, no lead damage
- * Lead-free solder joint, no wire bond & lead frame
- * Low power loss, High efficiency
- * High current capability
- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0

● APPLICATION

- * AC/DC Power Supply
- * Communication Equipment

● MECHANICAL DATA

Case : Packed with FRP substrate and epoxy underfilled

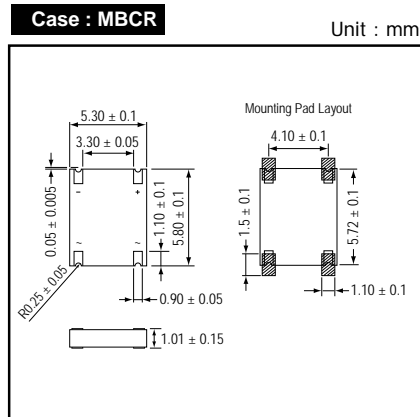
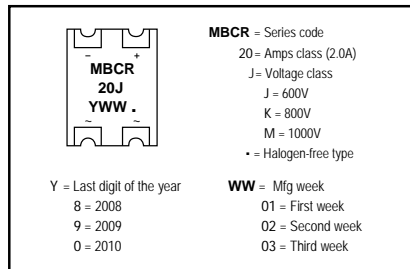
Terminals : Pure Tin plated (Lead-Free), solderable per MIL-STD-750, Method 2026.

Polarity : Laser marking symbols

Weight : 0.07 gram

● PACKING

- * 5,000 pieces per 13" (330mm ± 2mm) reel
- * 2 reels per box
- * 5 boxes per carton

● OUTLINE DIMENSIONS

● MARKING

Absolute Maximum Ratings (Ta = 25 °C)

ITEM	Symbol	Conditions	Rating			Unit
			MBCR20JH	MBCR20KH	MBCR20MH	
Repetitive peak reverse voltage	VRRM		600	800	1000	V
Average forward current	IF(AV)		2.0			A
Peak forward surge current	IFSM	8.3ms single half sine-wave	50			A
Operating storage temperature Range	Tj,TSTG		-55 to +175			°C

Electrical characteristics (Ta = 25 °C)

ITEM	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F = 2.0A	-	0.95	1.00	V
Repetitive peak reverse current	I _{RRM}	V _R = Max. V _{RRM} , Ta = 25 °C	-	0.08	5	uA
Current squared time	I ² t	t < 8.3ms, Ta = 25 °C	-	10.4	-	A ² s
Junction capacitance	C _j	V _R = 4V, f = 1.0 MHz	-	25	-	pF
Thermal resistance	R _{th(JA)}	Junction to ambient (NOTE)	-	95	-	°C/W
	R _{th(JL)}	Junction to lead (NOTE)	-	15	-	

NOTES : Thermal resistance, junction to ambient, measured on PC board with 5.0 x 5.0mm (0.03mm thick) land areas.

FIG.1 - FORWARD CURRENT DERATING CURVE

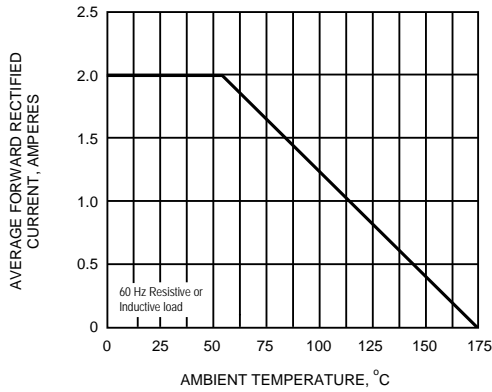


FIG.2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

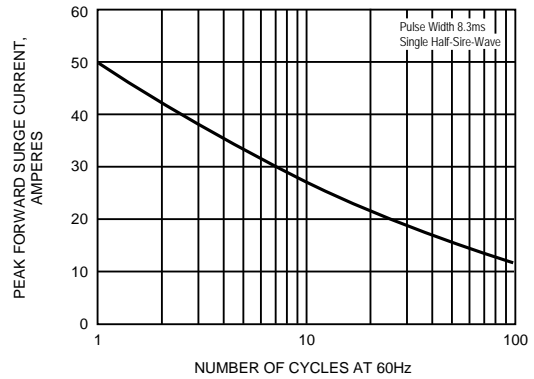


FIG.3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

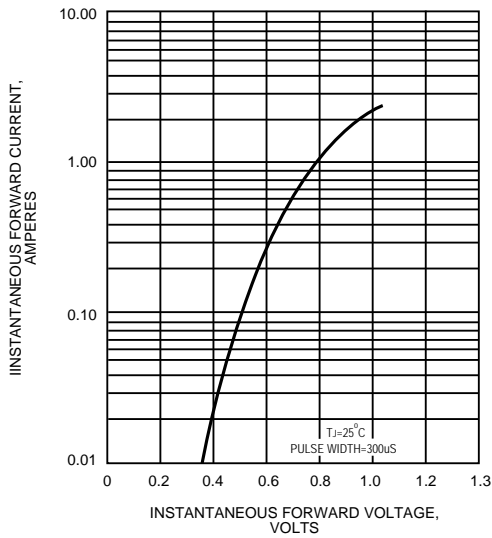


FIG.4 - TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT

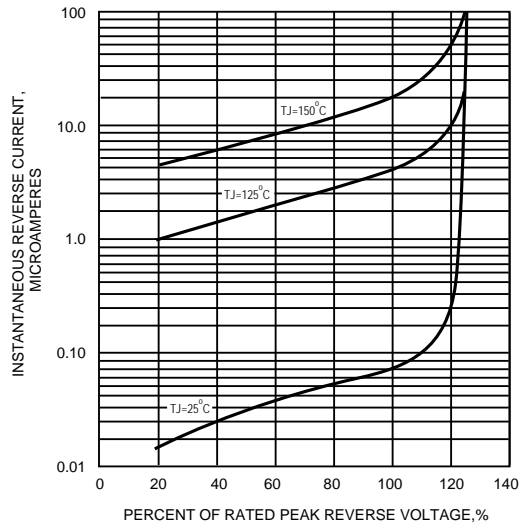


FIG.5 - TYPICAL JUNCTION CAPACITANCE

